

## MICROCIRCUIT DATA SHEET

MNLM1575-ADJ-X REV 2C1

Original Creation Date: 09/08/95 Last Update Date: 05/22/00 Last Major Revision Date: 09/08/95

## SIMPLE SWITCHER(TM) 1A STEP-DOWN VOLTAGE REGULATOR

#### General Description

The LM1575 regulator is a monolithic integrated circuit that provides all the active functions for a step-down (buck) switching regulator, capable of driving 1A load with excellent line and load regulation.

Requiring a minimum number of external components, this regulator is simple to use and includes internal frequency compensation and a fixed-frequency oscillator.

The LM1575 offers a high-efficiency replacement for popular three-terminal linear regulators. It substantially reduces the size of the heat sink, and in many cases no heat sink is required.

A standard series of inductors optimized for use with the LM1575 are available from several different manufacturers. This feature greatly simplifies the design of switch-mode power supplies.

Other features include a guaranteed  $\pm 4$ % tolerance on output voltage within specified input voltages and output load conditions, and  $\pm 10$ % on the oscillator frequency. External shutdown is included, featuring 50uA (typical) standby current. The output switch includes cycle-by-cycle current limiting, as well as thermal shutdown for full protection under fault conditions.

#### Industry Part Number

NS Part Numbers

LM1575J-ADJ-QML LM1575K-ADJ-QML LM1575WGADJ-OML

LM1575-ADJ

#### Prime Die

LM1575-ADJ

### Controlling Document

SEE FEATURES SECTION

#### Processing

MIL-STD-883, Method 5004

### Quality Conformance Inspection

MIL-STD-883, Method 5005

1Static tests at+252Static tests at+1253Static tests at-554Dynamic tests at+25	Subgrp	Description	Temp	(
5 Dynamic tests at +125 6 Dynamic tests at -55 7 Functional tests at +25 8A Functional tests at +125 8B Functional tests at -55 9 Switching tests at +25 10 Switching tests at -55 11 Switching tests at -55	2 3 4 5 6 7 8A 8B 9 10	Static tests at Static tests at Dynamic tests at Dynamic tests at Functional tests at Functional tests at Functional tests at Switching tests at	+125 -55 +25 +125 -55 +25 +125 -55 +25 +25 +125	

°C)

### Features

- Adjustable version output voltage range, 1.23V to 37V  $\pm4\%$  max over line and load conditions
- Guaranteed 1A output current
- Requires only 4 external components
- 52KHz fixed frequency internal oscillator
- TTL shutdown capability, low power standby mode
- High efficiency
- Uses readily available standard inductors
- Thermal shutdown and current limit protection

CONTROLLING DOCUMENTS:

LM1575J-ADJ-QML	5962-9167101MEA
LM1575K-ADJ-QML	5962-9167101MXA
LM1575WGADJ-QML	5962-9167101QZA

## Applications

- Simple high-efficiency step-down (buck) regulator
- Efficient pre-regulator for linear regulators
- On-card switching regulators
- Positive to negative converted (Buck-Boost)

(Absolute	Maximum	Ratings)
(Note 1)		-

Maximum Supply V	Toltage	45v
$\overline{\text{ON}}/\text{OFF}$ Pin Input	Voltage	-0.3V <u>&lt;</u> V≤ +Vin
Output Voltage t (Steady Stat		-1V
Power Dissipatic (Note 2, 3)	n	
Storage Temperat	ure Range	Internally Limited
Lead Temperature		-65 C <u>&lt;</u> Ta <u>&lt;</u> +150 C
(Soldering, METAL CAN CERDIP CERAMIC SOI	10 seconds)	300 C 260 C 260 C
Maximum Junction	Temperature	150 C
Thermal Resistar ThetaJA	ice	
METAL CAN CERDIP	(Still Air) (500LF/Min Air Flow) (Still Air)	45 C/W 10 C/W 70 C/W
	(500LF/Min Air Flow) ! (Still Air) (500LF/Min Air Flow)	33 C/W 121 C/W 73 C/W
ThetaJC (Note 3)		
METAL CAN	3 applicable to this Pkg only)	3.3 C/W 2.0 C/W 3.0 C/W
Package Weight (Typical) METAL CAN		TBD
CERDIP CERAMIC SOIC	2	TBD TBD
ESD Tolerance (Note 4)		
		2000V

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specification apply when the device is not operated under the listed test conditions. The maximum power dissipation must be derated at elevated temperatures and is dictated by Tjmax (maximum junction temperature), ThetaJA (package junction to

Note 2: ambient thermal resistance), and TA (ambient temperature). The maximum allowable power dissipation at any temperature is Pdmax = (Tjmax - TA)/ThetaJA or the number given in the Absolute Maximum Ratings, whichever is lower.

### (Continued)

- Note 3: The package material for these devices allows much improved heat transfer over our standard ceramic packages. In order to take full advantage of this improved heat transfer, heat sinking must be provided between the package base (directly beneath the die), and either metal traces on, or thermal vias through, the printed circuit board. Without this additional heat sinking, device power dissipation must be calculated using junction-to-ambient, rather than junction-to-case, thermal resistance. It must not be assumed that the device leads will provide substantial heat transfer out of the package, since the thermal resistance of the leadframe material is very poor, relative to the material of the package base. The stated junction-to-case thermal resistance is for the package material only, and does not account for the additional thermal resistance between the package base and the printed circuit board. The user must determine the value of the additional thermal resistance and must combine this with the stated value for the package, to calculate the total allowed power dissipation for the device.
- Note 4: Human body model, 1.5k Ohms in series with 100pF.

## Recommended Operating Conditions

Temperature Range

Supply Voltage

-55 C ≤ Ta ≤ +125 C

40V

## Electrical Characteristics

## ELECTRICAL CHARACTERISTICS: SYSTEM PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.) DC: Vin = 12V and Iload = 200mA.

SYMBOL	PARAMETER	CONDITIONS NOT		PIN- NAME	MIN	MAX	UNIT	SUB- GROUPS
Vfb	Feedback Voltage	Vout = Vfb	1		1.217	1.243	V	1
Vfbt	Feedback Voltage	$0.2A \leq Iload \leq 1A$ , $8V \leq Vin \leq 40V$ , Vout = Vfb	1		1.205	1.255	V	1
			1		1.193	1.267	V	2, 3

### ELECTRICAL CHARACTERISTICS: DEVICE PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.) DC: Vin = 12V and Iload = 200mA.

Ib	Feedback Bias Current	Vout = Vfb			100	nA	1
					500	nA	2, 3
Vsat	Saturation Voltage	Iout = 1A	2		1.2	V	1
	Voreage		2		1.4	V	2, 3
Icl	Current Limit	Peak Current, tON ≤ 3uS	2	1.7	3.0	A	1
			2	1.3	3.2	A	2, 3
Il	Output Leakage Current	Vin = $35V$ , Output = $0V$	4		2	mA	1
	Current	Vin = $35V$ , Output = $-1V$	4		30	mA	1
Iq	Quiescent Current		4		10	mA	1
			4		12	mA	2, 3
Istby	Standby Quiescent Current	$\overline{ON}/OFF$ Pin = 5V (OFF)			200	uA	1
					500	uA	2, 3

#### AC ELECTRICAL CHARACTERISTICS: DEVICE PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.) DC: Vin = 12V and Iload = 200mA.

fo	Oscillator Frequency		47	58	KHz	4
			43	62	KHz	5,6
Dc	Max Duty Cycle (ON)	3	93		010	9

## Electrical Characteristics

## ELECTRICAL CHARACTERISTICS: ON/OFF CONTROL

(The following conditions apply to all the following parameters, unless otherwise specified.) DC: Vin = 12V and Iload = 200mA.

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN- NAME	MIN	MAX	UNIT	SUB- GROUPS
Vih	ON/OFF Pin Logic Input Level	Vout = 0V			2.2		V	1
Vih	ON/OFF Pin Logic Input Level	Vout = 0V			2.4		V	2, 3
Vil	ON/OFF Pin Logic Input Level	Vout = 5V				1.0	V	1
Vil	ON/OFF Pin Logic Input Level	Vout = 5V				.8	V	2, 3
Iih	ON/OFF Pin Input Current	$\overline{ON}/OFF$ Pin = 5V (OFF)				30	uA	1
Iil	ON/OFF Pin Input Current	$\overline{ON}/OFF$ Pin = OV (ON)				10	uA	1

Note 1: External components such as the catch diode, inductor, input and output capacitors can affect switching regulator system performance.

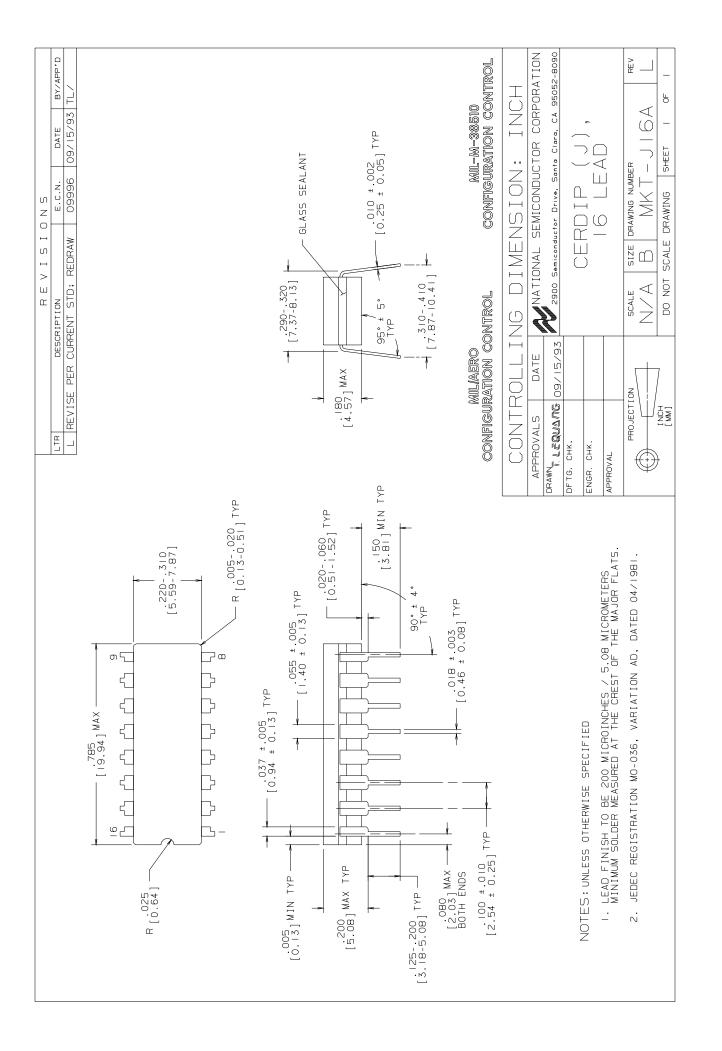
Note 2: Note 3: Output pin sourcing current. No diode, inductor or capacitor connected to output. Feedback removed from output and connected to 0V.

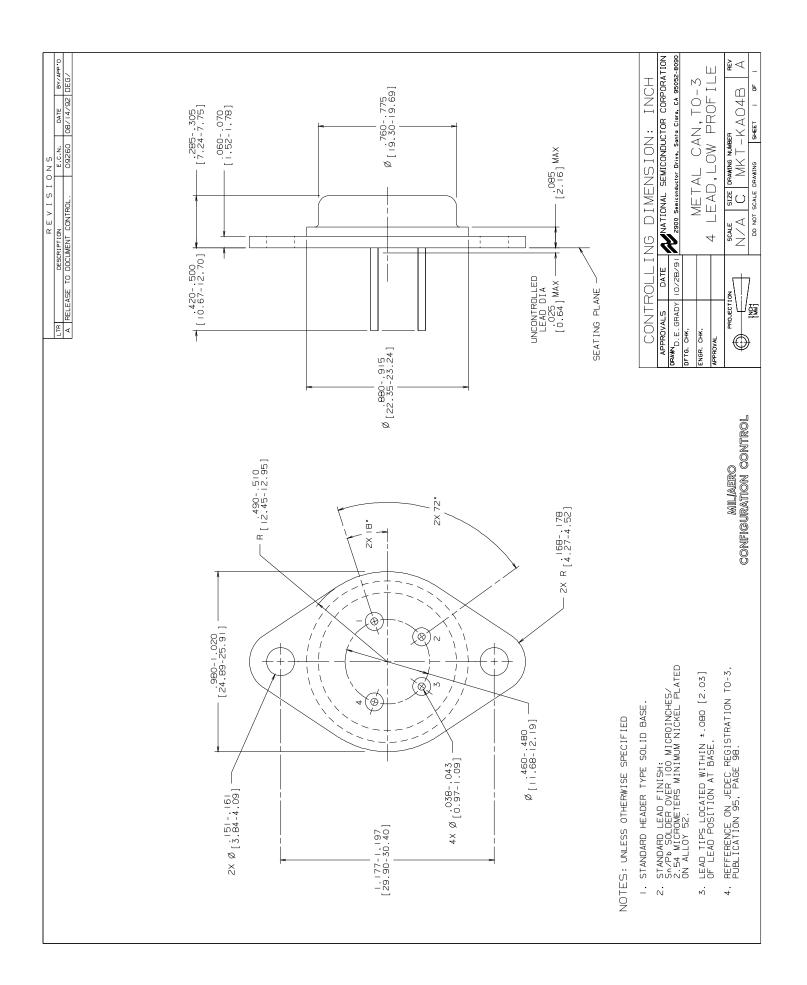
Note 4: Feedback removed from output and connected to 12V to force the output transistor OFF.

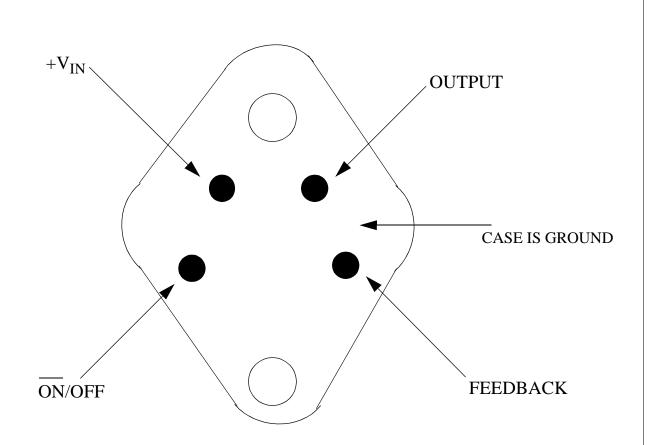
## Graphics and Diagrams

GRAPHICS#	DESCRIPTION
06153HRA2	METAL CAN (KA), TO-3, 4LD, LOW PROFILE (B/I CKT)
06265HRB2	CERDIP (J), 16 LEAD (B/I CKT)
06379HRA1	CERAMIC SOIC (WG), 16 LEAD (B/I CKT)
J16ARL	CERDIP (J), 16 LEAD (P/P DWG)
KA04BRA	METAL CAN (KA), TO-3, 4 LEAD, LOW PROFILE(P/P DWG)
P000232A	METAL CAN (KA), TO-3, 4LD, LOW PROFILE (PINOUT)
P000371A	CERDIP (J), 16 LEAD (PINOUT)
P000464A	CERAMIC SOIC (WG), 16 LEAD (PIN OUT)
WG16ARC	CERAMIC SOIC (WG), 16 LEAD (P/P DWG)

See attached graphics following this page.

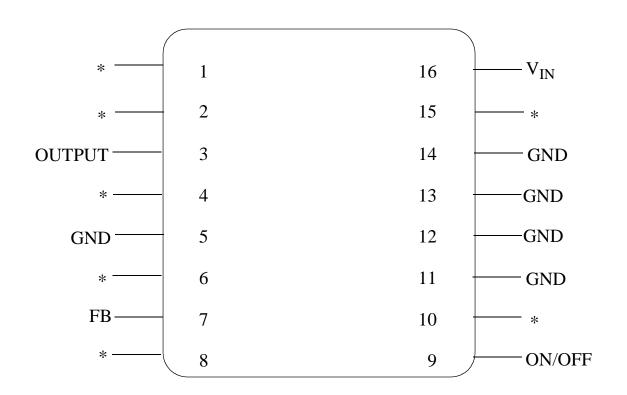






# LM1575K, LM1575HVK 4 - LEAD TO-3 CONNECTION DIAGRAM BOTTOM VIEW P000232A



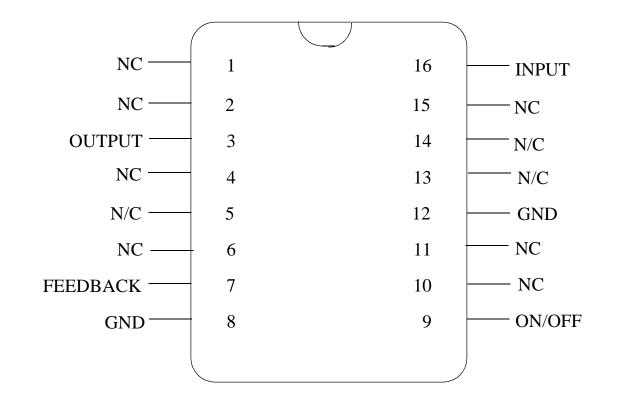


<sup>\*</sup>No Internal Connection

## LM1575J 16 - LEAD DIP CONNECTION DIAGRAM TOP VIEW P000371A

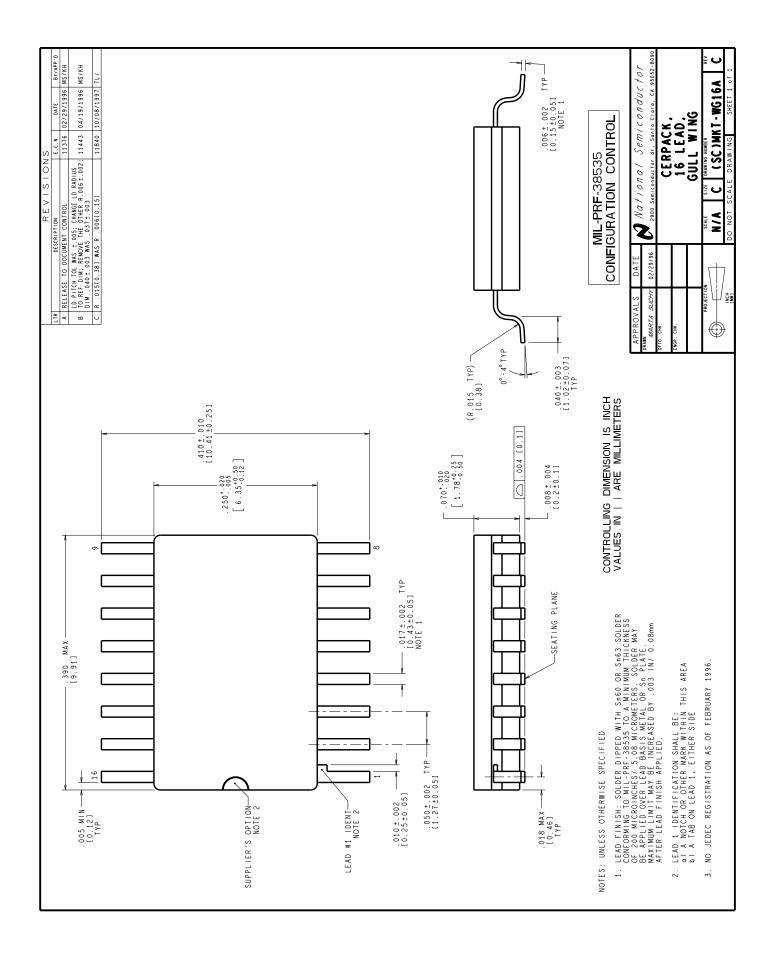


SANTA CLARA, CA 95050



# LM1575WG 16 - LEAD CERAMIC SOIC CONNECTION DIAGRAM TOP VIEW P000464A





## Revision History

Rev	ECN #	Rel Date	Originator	Changes				
280	R A		Barbara Lopez	Changed: MNLM1575-X-ADJ Rev. 2A0 to MNLM1575-ADJ-X Rev. 2B0. Added note for power dissipation for Aluminum Nitride package. Changed NSID to reflect device. Changed nomenclature.				
2C1	M0003690	05/22/00	Rose Malone	Update MDS: MNLM1575-ADJ-X, Rev. 2B0 to MNLM1575-ADJ-X, Rev. 2C1. Added reference to WG package to Main Table, Market Dwg., B/I Ckt., Pin Ou to Graphics Section and to Absolute Maximum Ratings Section. Moved Controlling Documents (SMD numbers) t Features Section. Corrected typo in Recommended Operating Conditions Section.				